

Title (en)  
PROCESS FOR THE IN-LINE DRYING OF POLYAMIDE/IMIDE WIRE ENAMELS CONTAINING N-METHYLPYRROLIDONE IN ENAMEL-APPLICATION UNITS.

Title (de)  
VERFAHREN ZUR INLINE-TROCKNUNG VON N-METHYLPYRROLIDON ENTHALTENDEN POLYAMIDIMIDRAHTLACKEN IN LACKIERANLAGEN.

Title (fr)  
PROCEDE DE SECHAGE EN LIGNE DE VERNIS POUR FILS DE FER EN POLYAMIDIMIDE CONTENANT DU N-METHYLPYRROLIDON DANS DES INSTALLATIONS DE LAQUAGE.

Publication  
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Application  
**EP 91903197 A 19910122**

Priority  
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Abstract (en)  
[origin: WO9112087A1] The invention concerns a process for drying polyamide/imide wire enamels containing N-methylpyrrolidone, the enamels having a viscosity of at least 100 mPa.s at 23 C. The enamel is passed in a closed cycle in the application unit between the enamel supplier and the storage tank, being pumped through one or more vessels containing a drying agent.

Abstract (fr)  
Un procédé permet de sécher des vernis pour fils de fer en polyamidimide contenant du N-méthylpyrrolidone et ayant des viscosités d'au moins 100 mPa à 23 °C. Les vernis circulent dans les installations de laquage entre le distributeur de laque et le réservoir et sont pompés à travers un ou plusieurs récipients qui contiennent un milieu de séchage.

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**B01D 15/00**; **B05D 1/00**

IPC 8 full level  
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